

FIG. 1

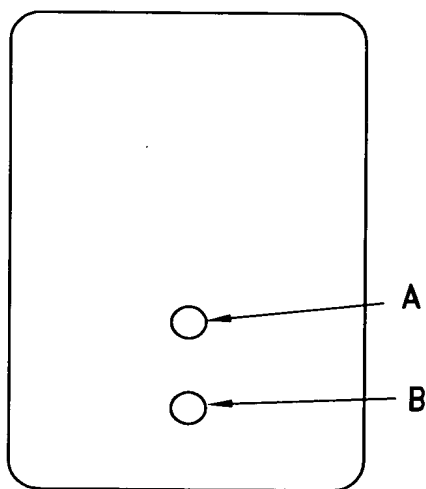


FIG. 1A

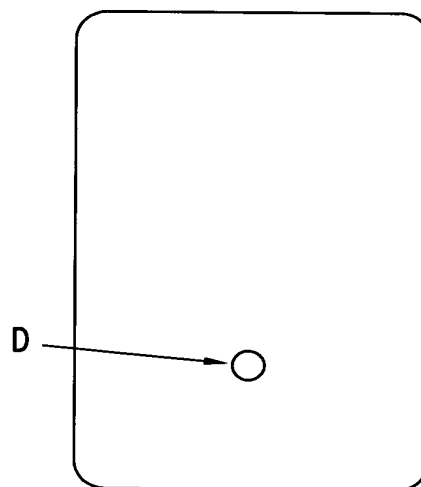


FIG. 1B

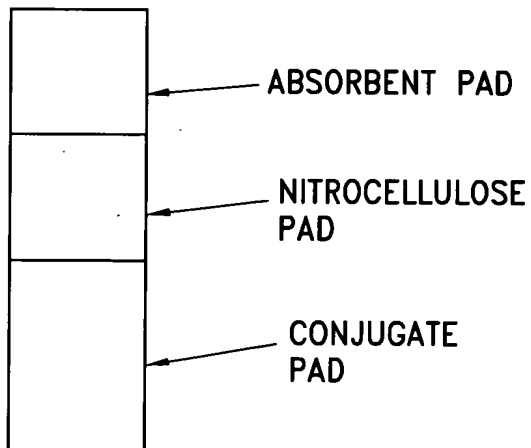


FIG. 1C

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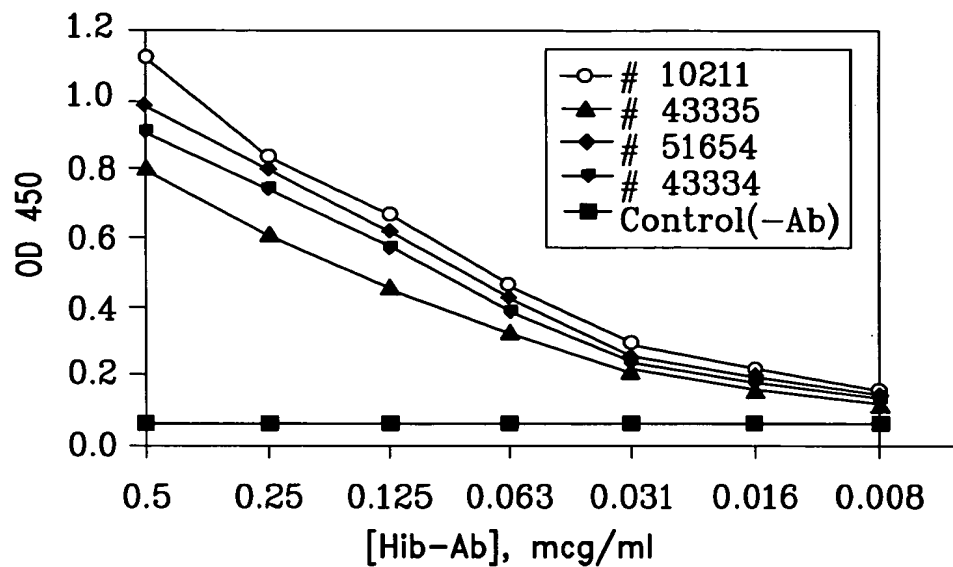


FIG. 2

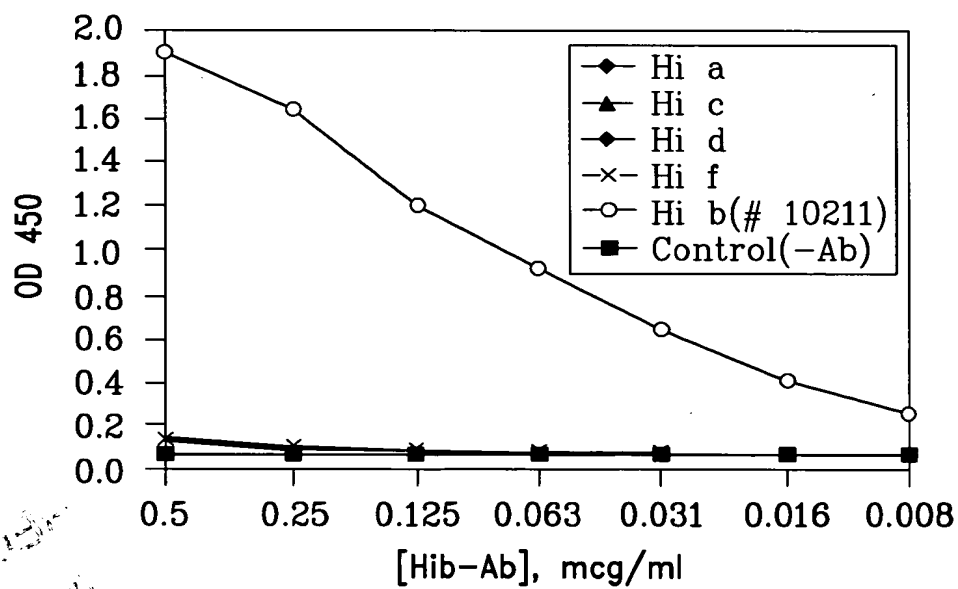


FIG. 3

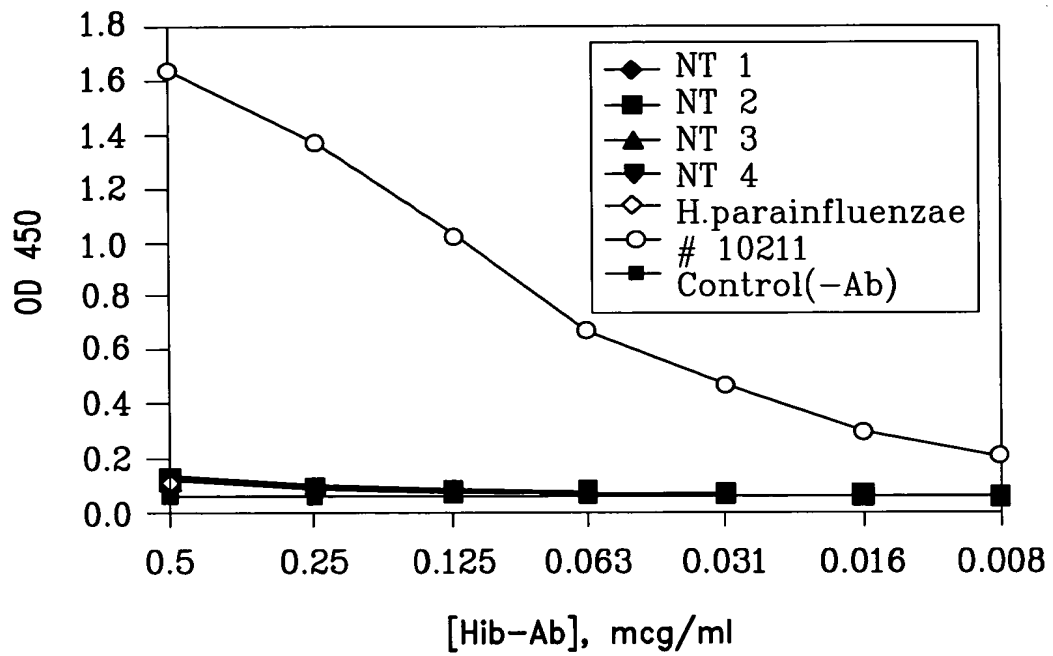


FIG. 4

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